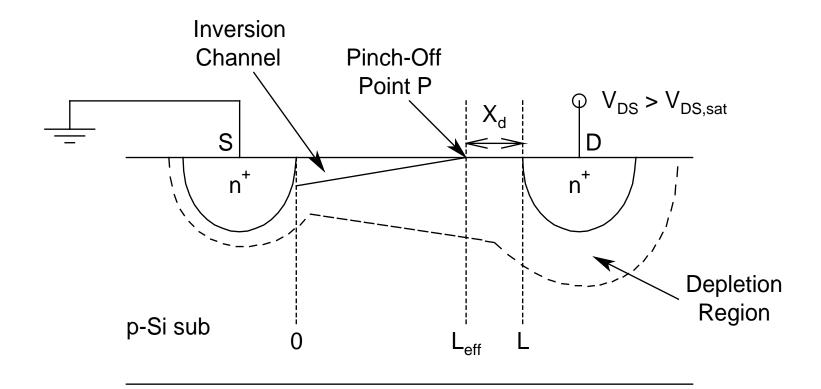
## **Channel Length Modulation (CLM)**



X<sub>d</sub> → length of the pinched-off region

- For  $V_{DS} = V_{DS,sat}$ , pinch-off point P at D end
- For  $V_{DS} > V_{DS,sat}$ , *P moves towards source*
- *Effective channel length reduces* from L to  $L_{eff} = L X_d$ 
  - X<sub>d</sub> = pinch-off region/drain region/saturation region length
- Excess voltage  $(V_{DS} V_{DS,sat})$  drops across  $X_d$

- Reduction of effective channel length causes an increase in current
  - > Channel length modulation
- With  $V_{DS}\uparrow$ ,  $X_d\uparrow$ ,  $L_{eff}\downarrow$ , and  $I_D\uparrow$ 
  - > No real current saturation
- Thus, saturated drain current:

$$I_{D,sat} = (k'_{N}/2)(W/L_{eff})V_{GT}^{2}$$
$$= (k_{N}/2)V_{GT}^{2}(1+\lambda V_{DS})$$

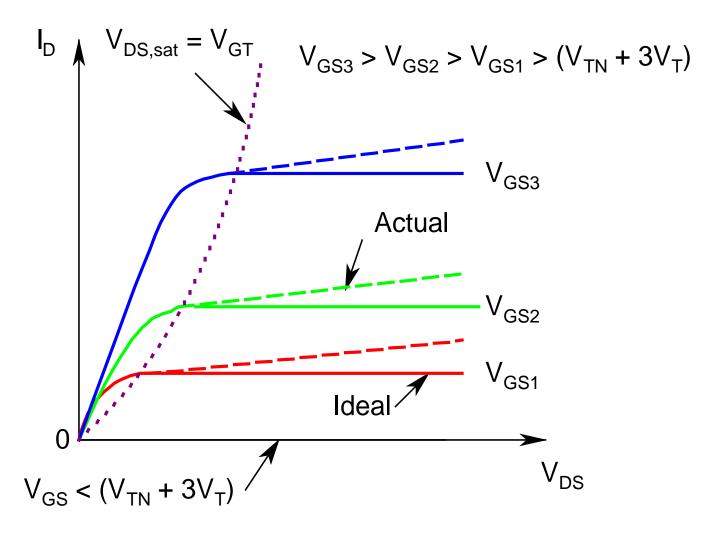
•  $\lambda$  = Channel length modulation parameter

$$= \frac{1}{L} \frac{dX_d}{dV_{DS}}$$

- Function of L and  $N_A$
- Higher L and  $N_A => Lower \lambda$
- Typical values of  $\lambda$  may range from close to 0 to as high as 0.1-0.3  $V^{-1}$
- Very similar to V<sub>A</sub> for BJTs

• This gives *LEVEL 1 model* (also known as *Shichman-Hodges model*) for MOSFETs:

$$\begin{split} I_{D} &= k_{N} \Big[ V_{GT} V_{DS} - V_{DS}^{2} / 2 \Big] \big( 1 + \lambda V_{DS} \big) \\ &\qquad \qquad (\textit{linear region} - V_{GT} > 3 V_{T}, V_{DS} < V_{GT} \big) \\ &= \big( k_{N} / 2 \big) V_{GT}^{2} \, \big( 1 + \lambda V_{DS} \big) \\ &\qquad \qquad (\textit{saturation region} - V_{GT} > 3 V_{T}, V_{DS} \ge V_{GT} \big) \\ &= 0 \\ &\qquad \qquad (\textit{cutoff region} - V_{GT} \le 3 V_{T}, \text{ any } V_{DS} \big) \end{split}$$



I<sub>D</sub>-V<sub>DS</sub> Characteristics in presence of CLM